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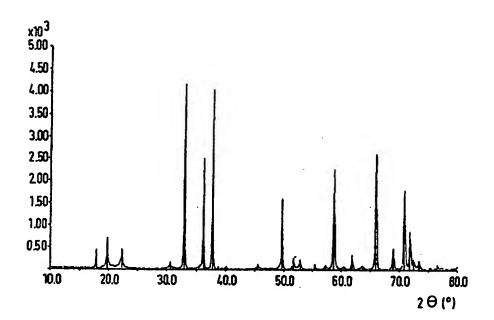
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(54) Title: SUBSTRATE OF A CERAMIC MATERIAL



(57) Abstract

The invention relates to a substrate made from a novel type of ceramic material. This material comprises 44-47 at. % Al, 31-39 at. % O, 8-13 at. % C and 8-12 at. % N. Substrates made from this material exhibit a relatively high heat conductance, a relatively great strength and their coefficient of expansion is equal to that of Si. Consequently, the substrates in accordance with the invention are very suitable for use in the Si-semiconductor technology. The main component of the ceramic material of the substrates preferably corresponds to the formula Al<sub>28</sub>O<sub>21</sub>C<sub>6</sub>N<sub>6</sub>. The invention also provides methods of manufacturing substrates and other mouldings from this material.

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Substrate of a ceramic material.

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The invention relates to a substrate made from a ceramic material. The invention also relates to a ceramic material and to methods of manufacturing such a ceramic material.

Substrates made from a ceramic material are known per se. They are generally composed of a thin sheet of sintered ceramic material, such as the binary compounds aluminium oxide (Al<sub>2</sub>O<sub>3</sub>), magnesium oxide (MgO), beryllium oxide (BeO), aluminium nitride (AIN) or silicon carbide (SiC). Substrates made from ternary compounds, such as MgSiN<sub>2</sub>, are also known. Because of their satisfactory electrically insulating properties, said known substrates are used in passive and active electrical components, such as resistors, capacitors, transformers and power transistors. In these applications, they serve as supports of current-conducting structures. In Patent Application US 5.411.924, filed by Applicant, the advantages and disadvantages of a number of substrates are briefly stated.

An important field of application of ceramic substrates is formed by the Si-semiconductor technology. Substrates suitable for said technology must have a high 15 electrical resistance R (ohm), a satisfactory strength  $\sigma$  (MPa) and a high thermal conductance k (W/m.K). In addition, the coefficient of expansion  $\alpha$  (1/K) of the substrates should be substantially equal to that of Si. Said last-mentioned measure ensures that Si structures provided on the substrate do not crack and/or become detached under the influence of variations in temperature. The coefficient of expansion of silicon is approximately 4.8.10<sup>-6</sup> K<sup>-1</sup>.

As a result of said requirements, the use of magnesium oxide and aluminium oxide as the substrate material is not optimal because their thermal conductance is too low and their coefficient of expansion is too high. Said disadvantages apply in particular when these substrates are used in large Si-semiconductor structures and/or "power devices". The coefficient of expansion of MgSiN<sub>2</sub> (5.8.10<sup>6</sup> K<sup>-1</sup>) is much closer to that of Si than that of aluminium oxide and magnesium oxide. However, particularly in the case of relatively large substrate surfaces of MgSiN<sub>2</sub>, on which complex semiconductor structures are provided, the difference between the coefficients of expansion of Si and MgSiN, is still too large. Ceramic substrates of silicon carbide are relatively expensive because this material is difficult to

process. In addition, silicon carbide has a relatively high dielectric constant. As a result, this material is less suitable for use as a substrate in electronic components. Ceramic bodies of beryllium oxide have the important disadvantage that they comprise toxic beryllium. Substrates of aluminium nitride exhibit a favourable, high thermal conductance (approximately 150 W/m.K) and a coefficient of expansion (4.8.10<sup>-6</sup> K<sup>-1</sup>) which is substantially identical to that of Si. However, this material is difficult to manufacture and hence relatively expensive.

It is an object of the invention to provide a substrate of a ceramic material which does not have the above-mentioned disadvantages. The invention more particularly aims at providing a ceramic substrate which has a relatively high thermal conductance, a coefficient of expansion substantially equal to that of Si and which can be manufactured relatively easily and hence at low cost.

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These and other objects of the invention are achieved by a substrate of a ceramic material which is characterized in accordance with the invention in that the material comprises 44-47 at. % Al, 31-39 at. % O, 8-13 at. % C and 8-12 at. % N.

It has been found that a ceramic substrate whose composition is in accordance with the invention has substantially ideal properties for use in the Sisemiconductor technology. For example, the coefficient of expansion of the inventive substrate material is equal to that of Si, namely 4.8.10<sup>6</sup> K<sup>-1</sup>. In addition, the theoretical thermal conductance at 300 K is approximately 120 W/m.K. Further, the strength of the material is 295 MPa. These data show that the material has approximately the same favourable properties as AlN. Substrates in accordance with the invention, however, are much simpler and hence much cheaper to manufacture.

Experiments leading to the invention have shown that substantially

monophase material can only be obtained within the above-mentioned composition range.

Compositions outside said range generally comprise considerable quantities of other phases, such as aluminium oxide, aluminium oxynitride and/or aluminium oxycarbide. The presence of such foreign phases causes unfavourable properties, such as a substantial reduction of the thermal conductance. It is noted that a small part (up to 10 at.%) of Al can be replaced by B without this leading to a drastic change of the structure and properties of the inventive substrate.

The composition of the main component of the inventive substrate preferably corresponds to the formula Al<sub>28</sub>O<sub>21</sub>C<sub>6</sub>N<sub>6</sub>. The above-mentioned properties regarding thermal conductance, coefficient of expansion and strength are found to be optimal

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in substrates of this material composition. It is noted that the error in the element analysis of said composition is approximately 1 at. % per element. It is further noted that the composition formula is based on the crystal structure of the inventive material. The overall composition may differ slightly from the composition based on the crystal structure. This may be caused by the fact that the glass phase of the ceramic material differs from the crystalline phase. The glass phase is situated between the crystalline grains. The expression "main component" is to be understood to mean herein the crystalline phase of the material.

The invention also relates to a ceramic material. In accordance with the invention, this material is characterized in that it comprises 44-47 at. % Al, 31-39 at. % O, 8-13 at. % C and 8-12 at. % N. Preferably, the composition of the main component of the material corresponds to the formula  $Al_{22}O_{21}C_6N_6$ . The ceramic material in accordance with the invention may be in the form of a moulding or a powder.

The invention also relates to a method of manufacturing a ceramic material. A first embodiment is characterized in that the method comprises the following steps

- a) pre-firing a mixture of Al<sub>2</sub>O<sub>3</sub>, Al<sub>4</sub>C<sub>3</sub> and AlN in a ratio based on the intended composition of the ceramic material,
  - b) grinding the pre-fired product thus formed into a powder,
  - c) sintering the powder to form a ceramic material.

By means of the inventive method, a substantially monophase material is obtained which comprises 44-47 at. % Al, 31-39 at. % O, 8-13 at. % C and 8-12 at. % N. Prefiring preferably takes place in the temperature range between 1500 and 1700°C, and sintering preferably takes place in the temperature range between 1700 and 1900°C. Under these conditions, the quantity of foreign-phase material is less than 20 wt. %.

A second embodiment of the inventive method is characterized in that a mixture of Al<sub>2</sub>O<sub>3</sub>, Al<sub>4</sub>C<sub>3</sub> and AlN, in a ratio based on the intended composition of the ceramic material, is sintered under pressure to form said ceramic material. This method is commonly referred to as reactive sintering. In this method, pre-firing and grinding of the pre-fired product formed are dispensed with.

These and other aspects of the invention will be apparent from and elucidated with reference to the embodiments described hereinafter.

In the drawings:

Fig. 1 shows a substrate of a ceramic material in accordance with the invention,

Fig. 2 shows an X-ray diffraction pattern of the ceramic material in accordance with the invention.

In Fig. 1, reference numeral (1) refers to a flat substrate of a ceramic material. The dimensions of this substrate are 40 x 60 x 4 mm<sup>3</sup>. The composition of the main 5 component of this ceramic material corresponds to the formula Al<sub>24</sub>O<sub>21</sub>C<sub>6</sub>N<sub>6</sub>. The substrate was manufactured as described hereinbelow.

The starting materials used were powders of Al<sub>2</sub>O<sub>3</sub> (CR-56, Baikowski), Al<sub>4</sub>C<sub>3</sub> (WI, Cerac) and AlN (Tokuyoma Soda, F-Grade). These starting materials were used to prepare a mixture comprising 57.2 wt. % aluminium oxide, 23.1 wt. % aluminium carbide 10 and 19.7 wt. % aluminium nitride. This powder mixture was compressed into pellets under a pressure of 5 MPa, said pellets were subsequently pre-fired at a temperature ranging between 1600 and 1650°C. The heating and cooling rates were 10°C per minute. After pre-firing of the pellets, they were ground into a powder having an average grain size of approximately 2 micrometers. Said powder was of a white colour.

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An X-ray diffraction pattern was recorded of the powder thus manufactured, as shown in Fig. 2. In said figure, the intensity (random unit) of the radiation measured is plotted as a function of 2  $\theta$  (°). The pattern was recorded by means of a Philips PW1800 diffractometer, while using monochromatic Cu-Kα radiation. All the lines of the pattern can be assigned to a rhombohedral structure (R-3m, #166, wherein a = 5.459 Å and c = 14.952 Å). This diamond-like structure explains why the material in accordance with the invention has a relatively high heat conductance. It could be derived from this diffraction pattern that the quantity of foreign-phase material is less than 5 wt. %. Element analysis showed that the composition of the ceramic material manufactured corresponded to the formula Al<sub>28</sub>O<sub>21</sub>C<sub>6</sub>N<sub>6</sub>. The error in the element analysis is maximally 1 at. %.

The powdered ceramic material having this optimum chemical composition was used to manufacture substrates by means of hot pressing. In this process, approximately 10 g of the powder was pressed by means of a hot-pressing apparatus (HP20, supplier Thermal Technology Ind) to form a flat substrate. The hot-pressed powder was sintered at a pressure of 75 MPa for 3 hours at 1800°C. The heating and cooling rates were 30 10°C per minute. After the hot-pressing operation, the substrate was subjected to a number of measurements. The density of the substrate was 97%. The heat conductance of this substrate was found to be above 20 W/m.K. Calculations revealed that the theoretical heat conductance is approximately 141 W/m.K. This can be achieved by optimizing the sintering process. The average coefficient of expansion of the substrate thus manufactured was 4.8·10-6 K-1. The strength of the material was 295 MPa.

In further experiments, a mixture of the above-mentioned aluminium oxide, aluminium oxycarbide and aluminium nitride were mixed and, immediately afterwards, subjected to a sintering treatment at an increased pressure for 3 hours at 1880-1900°C. The density of the material obtained ranges between 2.97 and 3.01 g/cm<sup>3</sup>. A favourable aspect of this so-called "reactive hot sintering method" is that the time-consuming pre-firing step as well as the grinding step can be dispensed with. In this manner, substrates or other mouldings can be manufactured rapidly and at low cost.

In still further experiments, a number of ceramic powders were manufactured, in which the quantity of the various elements of the ceramic material was 10 varied around the above-mentioned optimum composition. Also of these powders an X-ray diffraction pattern was recorded under the same conditions as described hereinabove. The quantity of different-phase material was estimated by means of the surface area of nonassignable peaks. The chemical composition and the corresponding quantity of monophase 15 material (pure phase) are listed in the Table

		Composition	pure phase (%)	
	1.	Al <sub>48</sub> O <sub>29</sub> C <sub>14</sub> N <sub>9</sub>	60	
	2.	Al <sub>47</sub> O <sub>31</sub> C <sub>13</sub> N <sub>9</sub>	80	
	3.	Al <sub>46</sub> O <sub>35</sub> C <sub>11</sub> N <sub>10</sub>	95	
	4.	Al <sub>46</sub> O <sub>36</sub> C <sub>10</sub> N <sub>9</sub>	98	
	5.	Al <sub>46</sub> O <sub>37</sub> C <sub>10</sub> N <sub>10</sub>	90	
	6.	Al <sub>44</sub> O <sub>39</sub> C <sub>8</sub> N <sub>11</sub>	80	
	7.	Al <sub>43</sub> O <sub>40</sub> C <sub>7</sub> N <sub>11</sub>	30	

The ceramic materials in accordance with exemplary embodiments 1 and 7 are not in accordance with the invention. The ceramic materials in accordance with exemplary embodiments 2-6 are in accordance with the invention. The Table clearly shows that a monophase material is obtained if the ceramic material in accordance with the invention comprises 44-47 at. % Al, 31-39 at. % O, 8-13 at. % C and 8-12 at. % N.

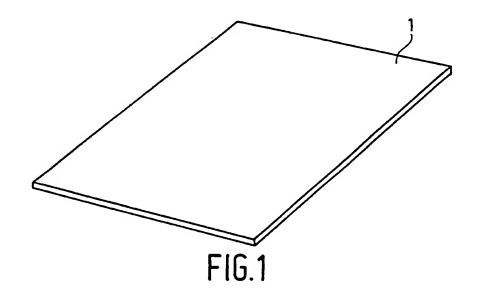
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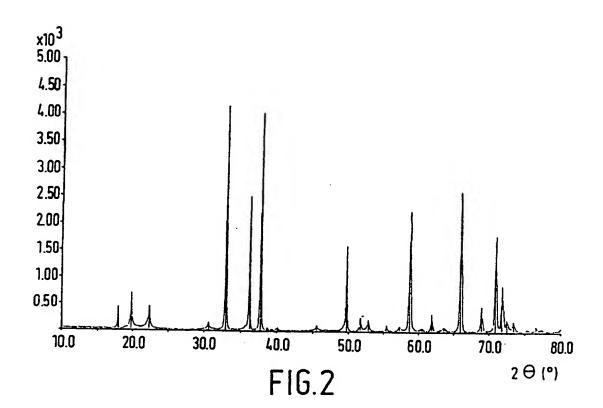
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In summary, the invention relates to a substrate made from a novel type of ceramic material. Said material comprises 44-47 at.% Al, 31-39 at.% O, 8-13 at.% C and 8-12 at.% N. Substrates made from this material exhibit a relatively high thermal conductance, a relatively great strength and their coefficient of expansion is equal to that of Si. Consequently, the substrates in accordance with the invention are very suitable for use in the Si-semiconductor technology. The main component of the ceramic material of the substrates preferably corresponds to the formula  $Al_{20}O_{21}C_6N_6$ . The invention also provides methods of manufacturing substrates and other mouldings from this material.

### **CLAIMS:**

- 1. A substrate of a ceramic material, characterized in that said material comprises 44-47 at. % Al, 31-39 at. % O, 8-13 at. % C and 8-12 at. % N.
- 2. A substrate as claimed in Claim 1, characterized in that the composition of the main component of the material corresponds to the formula  $Al_{2a}O_{2a}C_{6}N_{6}$ .
- A ceramic material, characterized in that said material comprises 44-47 at. % Al, 31-39 at. % O, 8-13 at. % C and 8-12 at. % N.
  - 4. A ceramic material as claimed in Claim 3, characterized in that the composition of the main component of the material corresponds to the formula Al<sub>28</sub>O<sub>21</sub>C<sub>6</sub>N<sub>6</sub>.
  - 5. A method of manufacturing a ceramic material as claimed in Claim 3 or
- 10 4, characterized in that the method comprises the following steps
  - a) pre-firing a mixture of Al<sub>2</sub>O<sub>3</sub>, Al<sub>4</sub>C<sub>3</sub> and AlN in a ratio based on the intended composition of the ceramic material,
    - b) grinding the pre-fired product into a powder,
    - c) sintering the powder to form a ceramic material.
- 15 6. A method as claimed in Claim 5, characterized in that pre-firing takes place in the temperature range between 1500 and 1700°C and in that sintering takes place in the temperature range between 1700 and 1900°C.
- 7. A method of manufacturing a ceramic material as claimed in Claim 3 or 4, characterized in that a mixture of Al<sub>2</sub>O<sub>3</sub>, Al<sub>4</sub>C<sub>3</sub> and Aln, in a ratio based on the intended composition of the ceramic material, is sintered under pressure to form said ceramic material.





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# INTERNATIONAL SEARCH REPORT

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A. CLASSIFICATION OF SUBJECT MATTER	
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Minimum documentation searched (classification system followed IPC6: C04B	by classification symbols)
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Category* Citation of document, with indication, where a	appropriate, of the relevant passages Relevant to claim No.
A EP 0490480 A1 (FORD-WERKE AKTIE 31 October 1991 (31.10.91), line 24 - line 26	ENGESELLSCHAFT), 1-7 , column 1,
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